

Rectifier Diode

5SDD 60Q2800

V_{RSM}	=	2800 V
$I_{F(AV)M}$	=	7385 A
$I_{F(RMS)}$	=	11600 A
I_{FSM}	=	$87 \cdot 10^3$ A
V_{F0}	=	0.8 V
r_F	=	0.05 m Ω

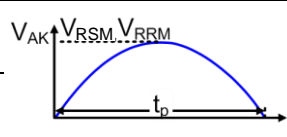
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- Patented free-floating silicon technology
- Very low on-state losses
- Optimum power handling capability

Blocking

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	Value	Unit
Max repetitive peak reverse voltage	V_{RRM}	$f = 50$ Hz, $t_p = 10$ ms, $T_{vj} = 0 \dots 160$ °C	2000	V
Max non-repetitive peak reverse voltage	V_{RSM}	$f = 5$ Hz, $t_p = 10$ ms, $T_{vj} = 0 \dots 160$ °C	2800	V



Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse leakage current	I_{RRM}	V_{RRM} , $T_{vj} = 0 \dots 160$ °C			400	mA

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		81	90	108	kN
Acceleration	a	Device unclamped			50	m/s ²
Acceleration	a	Device clamped			100	m/s ²

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m			2.1		kg
Housing thickness	H	$F_M = 90$ kN, $T_a = 25$ °C	25.8		26.2	mm
Surface creepage distance	D_S		36			mm
Air strike distance	D_a		15			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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On-state

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{F(AV)M}$	50 Hz, Half sine wave, $T_c = 90^\circ\text{C}$			7385	A
RMS on-state current	$I_{F(RMS)}$				11600	A
Peak non-repetitive surge current	I_{FSM}	$t_p = 10\text{ ms}$, $T_{vj} = 160^\circ\text{C}$, sine half wave, $V_R = 0\text{ V}$, after surge			$87 \cdot 10^3$	A
Limiting load integral	I^2t				$38.5 \cdot 10^6$	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_F	$I_F = 5000\text{ A}$, $T_{vj} = 160^\circ\text{C}$		1.02	1.05	V
Threshold voltage	V_{F0}	$T_{vj} = 160^\circ\text{C}$ $I_F = 2500 \dots 7500\text{ A}$			0.8	V
Slope resistance	r_F				0.05	$\text{m}\Omega$

Switching

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	Q_{rr}	$di_F/dt = -10\text{ A}/\mu\text{s}$, $V_R = 200\text{ V}$ $I_F = 4000\text{ A}$, $T_{vj} = 160^\circ\text{C}$	5400	6100	6700	μAs
Reverse recovery current	I_{RM}		220	270	300	A

Thermal

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T_{vj}		0		160	°C
Storage temperature range	T_{stg}		-40		150	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled $F_m = 81... 108 \text{ kN}$			5	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 81... 108 \text{ kN}$			10	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 81... 108 \text{ kN}$			10	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 81... 108 \text{ kN}$			1	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 81... 108 \text{ kN}$			2	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
R_i (K/kW)	3.560	0.680	0.460	0.280
τ_i (s)	0.4069	0.0559	0.0075	0.0018

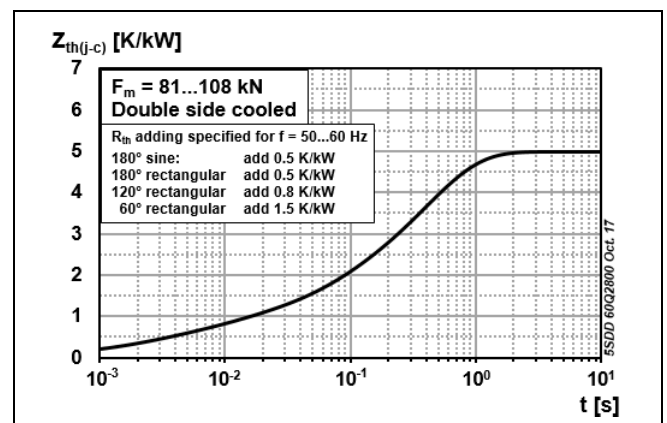


Fig. 1 Transient thermal impedance (junction-to-case) vs. time

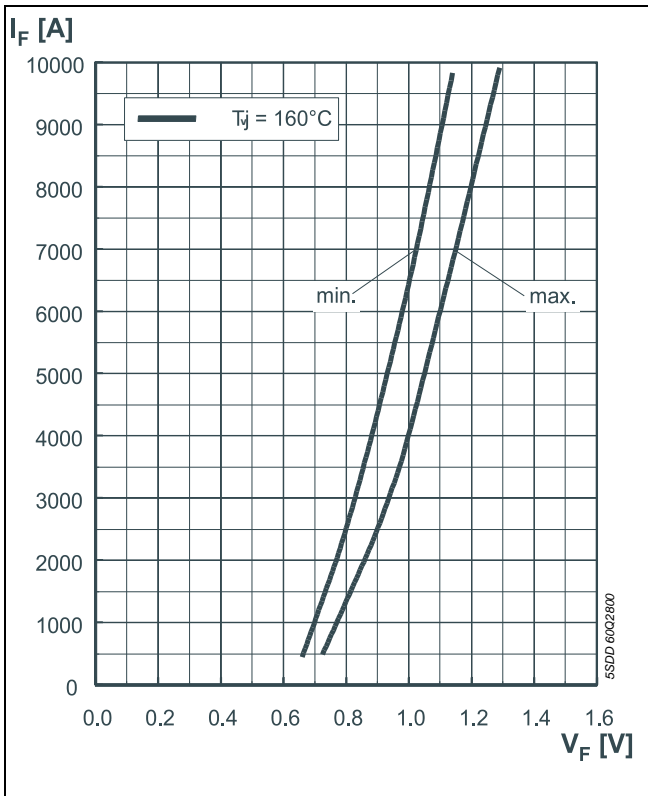


Fig. 2 On-state voltage characteristics

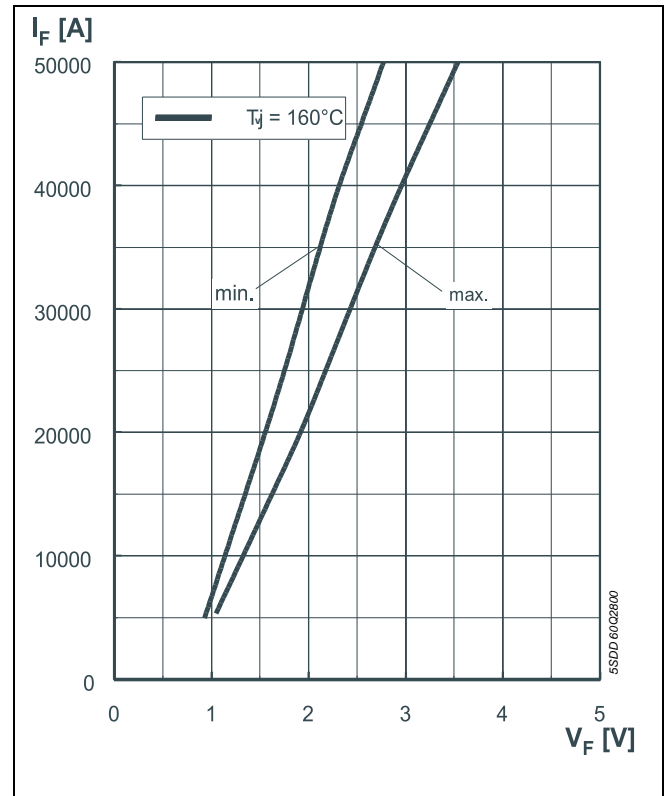


Fig. 3 On-state voltage characteristics

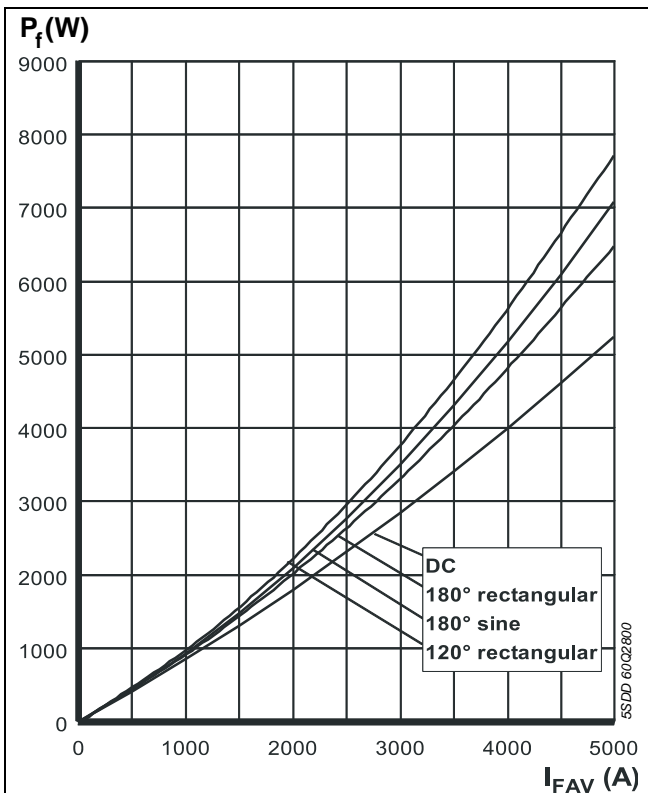


Fig. 4 On-state power dissipation vs. mean on-state current

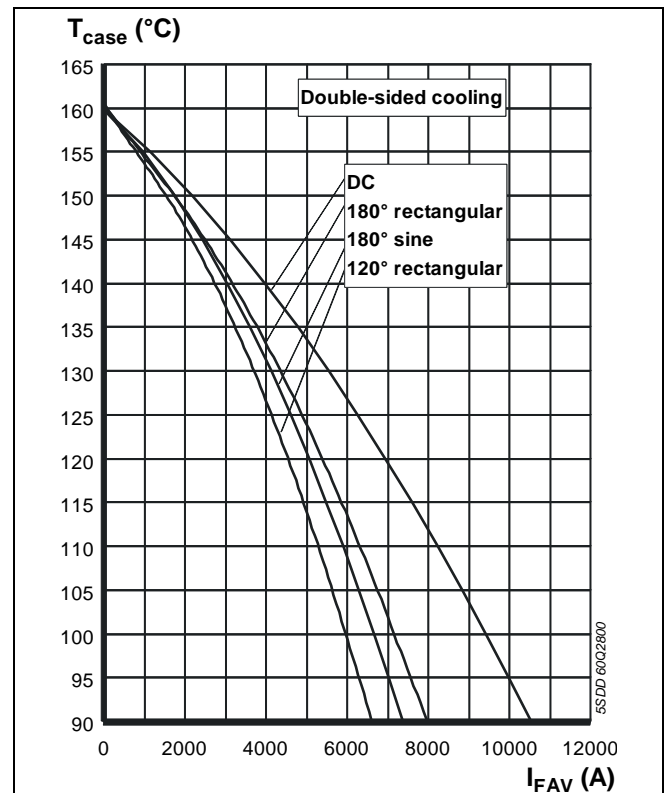


Fig. 5 Max. permissible case temperature vs. mean on-state current

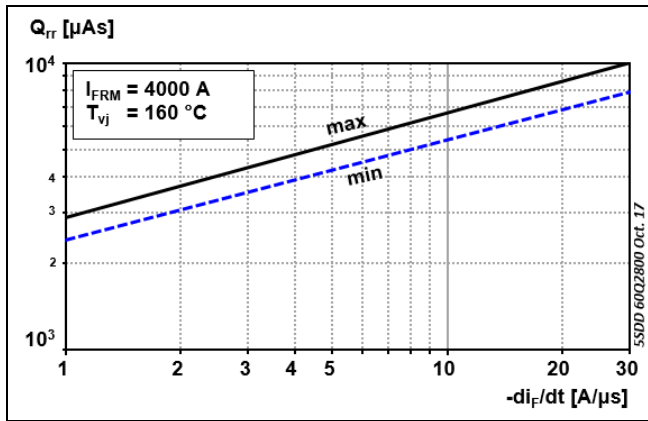


Fig. 6 Reverse recovery charge vs. decay rate of on-state current

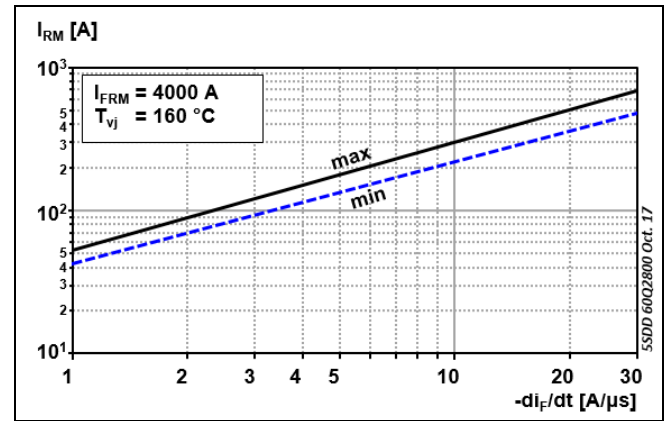


Fig. 7 Peak reverse recovery current vs. decay rate of on-state current

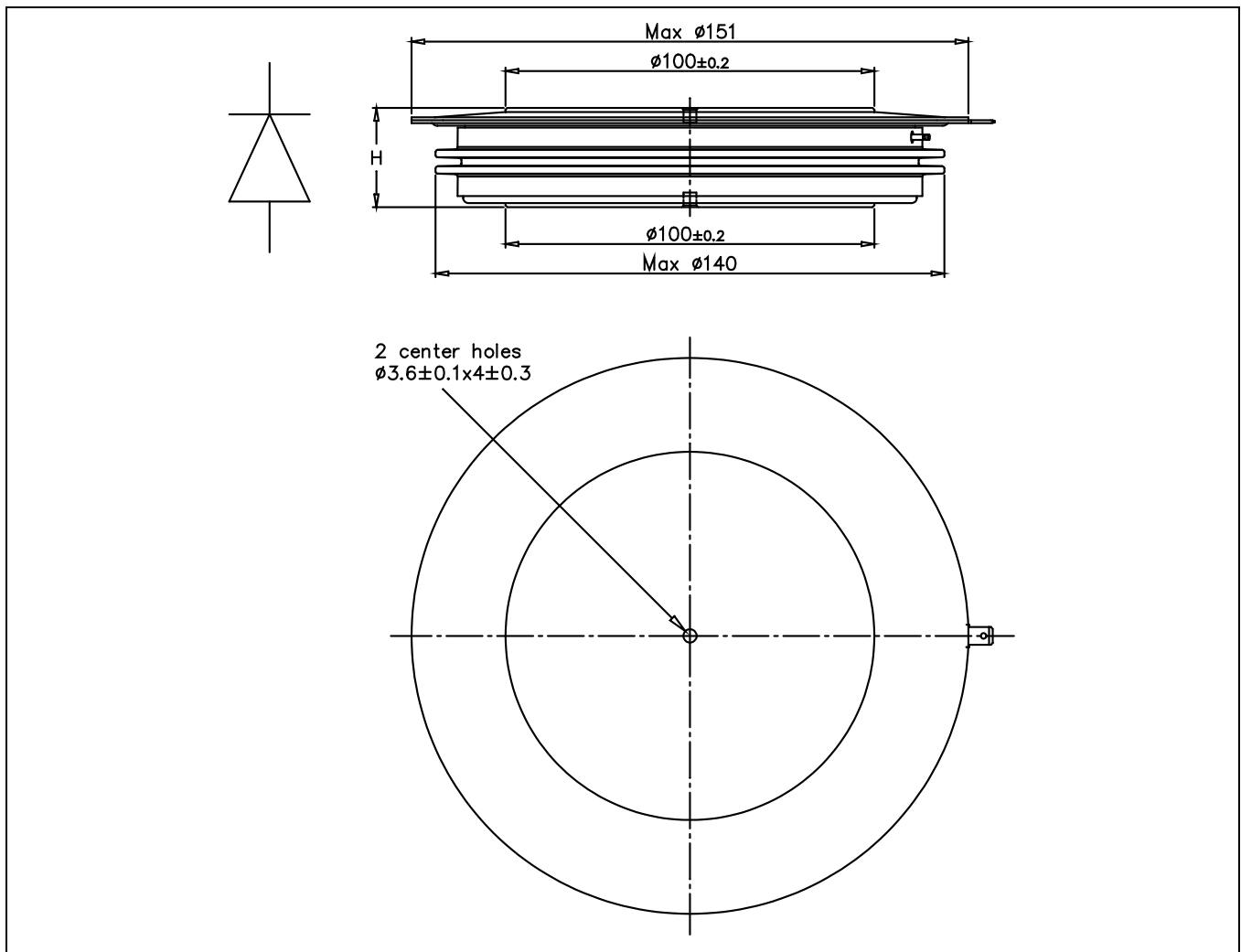


Fig. 8 Device Outline Drawing

Related documents:

5SYA 2020	Design of RC-Snubbers for Phase Control Applications
5SYA 2029	High Power Rectifier Diodes
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
5SYA 2048	Field Measurements on High Power Press-Pack Semiconductors
5SYA 2051	Voltage Ratings of High Power Semiconductors
5SZK 9104	Specification of environmental class for pressure contact diodes, PCTs and GTO, Storage
5SZK 9105	Specification of environmental class for pressure contact diodes, PCTs and GTO, Transportation
5SZK 9115	Specification of environmental class for presspack Diodes, PCTs and GTOs, Operation (Industry)
5SZK 9116	Specification of environmental class for presspack Diodes, PCTs and GTOs, Operation (Traction)

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